2020-2-27 Rev.2.0

RD Number: RD111

RD Title: TB67S508FTG Evaluation circuit BOM

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	C_VDD	0	10µF 10V	–	–	Electrolytic capacitor		✓
2	C_VM1	1	100µF 50V	–	–	Electrolytic capacitor		
3	C_VM2	0	Not mount	–	–	Ceramic capacitor		✓
4	C_VM3	1	0.1µF 50V	–	–	Ceramic capacitor		
5	C_VCC	1	0.1µF 6V	–	–	Ceramic capacitor		
6	C_VAD	1	0Ω 2A	–	–	Chip resistor		
7	C_OSCM	1	0Ω 2A	–	–	Chip resistor		
8	C_VREFA	1	0.1µF 50V	–	–	Ceramic capacitor		
9	C_VREFB	1	0.1µF 50V	–	–	Ceramic capacitor		
10	C_OBP	0	Not mount	–	–	Ceramic capacitor		✓
11	C_OBM	0	Not mount	–	–	Ceramic capacitor		✓
12	C_OAP	0	Not mount	–	–	Ceramic capacitor		✓
13	C_OAM	0	Not mount	–	–	Ceramic capacitor		✓
14	C_S1	0	Not mount	–	–	Ceramic capacitor		✓
15	C_S2	0	Not mount	–	–	Ceramic capacitor		✓
16	C_S3	0	Not mount	–	–	Ceramic capacitor		✓
17	C_S4	0	Not mount	–	–	Ceramic capacitor		✓
18	C_S5	0	Not mount	–	–	Ceramic capacitor		✓
19	C_S6	0	Not mount	–	–	Ceramic capacitor		✓
20	C_S7	0	Not mount	–	–	Ceramic capacitor		✓
21	C_S8	0	Not mount	–	–	Ceramic capacitor		✓
22	R_OSCM	0	Not mount	–	–	Chip resistor		✓
23		0	Not mount	–	–	Leaded resistor		✓
24	R_VREFA1	0	Not mount	–	–	Chip resistor		✓
25		0	Not mount	–	–	Leaded resistor		✓
26	R_VREFA2	0	Not mount	–	–	Chip resistor		✓

27		0	Not mount	–	–	Leaded resistor		✓
28	R_VREFB1	0	Not mount	–	–	Chip resistor		✓
29		0	Not mount	–	–	Leaded resistor		✓
30	R_VREFB2	0	Not mount	–	–	Chip resistor		✓
31		0	Not mount	–	–	Leaded resistor		✓
32	R_ERR	0	Not mount	–	–	Chip resistor		✓
33		1	10kΩ 0.25W	–	–	Leaded resistor		
34	R_MO	0	Not mount	–	–	Chip resistor		✓
35		1	10kΩ 0.25W	–	–	Leaded resistor		
36	R_OSCM	2	Socket pin	–	–	Socket pin		
37	R_VREFA1	2	Socket pin	–	–	Socket pin		
38	R_VREFA2	2	Socket pin	–	–	Socket pin		
39	R_VREFB1	2	Socket pin	–	–	Socket pin		
40	R_VREFB2	2	Socket pin	–	–	Socket pin		
41	R_ERR	2	Socket pin	–	–	Socket pin		
42	R_MO	2	Socket pin	–	–	Socket pin		
43	GND1	1	Check terminal	–	–	Check pin		
44	GND2	1	Check terminal	–	–	Check pin		
45	GND3	1	Check terminal	–	–	Check pin		
46	GND4	1	Check terminal	–	–	Check pin		
47	GND5	1	Check terminal	–	–	Check pin		
48	GND6	1	Check terminal	–	–	Check pin		
49	GND7	1	Check terminal	–	–	Check pin		
50	GND8	1	Check terminal	–	–	Check pin		
51	VM	1	Check terminal	–	–	Check pin		
52	VDD	1	Check terminal	–	–	Check pin		
53	OSCM	1	Check terminal	–	–	Check pin		
54	CC	1	Check terminal	–	–	Check pin		
55	VREF_A	1	Check terminal	–	–	Check pin		
56	VREF_B	1	Check terminal	–	–	Check pin		
57	ISEL/ERR	1	Check terminal	–	–	Check pin		
58	VAD	0	Check terminal	–	–	Check pin		✓
59	IN_A1/CW_CCW	1	Check terminal	–	–	Check pin		
60	IN_A2/MO	1	Check terminal	–	–	Check pin		

61	IN_B1/DMODE1	1	Check terminal	–	–	Check pin		
62	IN_B2/DMODE2	1	Check terminal	–	–	Check pin		
63	STANDBY/CLK	1	Check terminal	–	–	Check pin		
64	PHASE_A/ENABLE	1	Check terminal	–	–	Check pin		
65	PHASE_B/RESET	1	Check terminal	–	–	Check pin		
66	OUT_B+	1	Check terminal	–	–	Check pin		
67	OUT_B-	1	Check terminal	–	–	Check pin		
68	OUT_A+	1	Check terminal	–	–	Check pin		
69	OUT_A-	1	Check terminal	–	–	Check pin		
70	SW1	1	Pin header 3P	–	–	Jumper		
71		1	Jumper socket	–	–	Jumper Short		
72	SW2	1	Pin header 3P	–	–	Jumper		
73		1	Jumper socket	–	–	Jumper Short		
74	SW3	1	Pin header 3P	–	–	Jumper		
75		1	Jumper socket	–	–	Jumper Short		
76	SW4	1	Pin header 3P	–	–	Jumper		
77		1	Jumper socket	–	–	Jumper Short		
78	SW5	1	Pin header 3P	–	–	Jumper		
79		1	Jumper socket	–	–	Jumper Short		
80	SW6	1	Pin header 3P	–	–	Jumper		
81		1	Jumper socket	–	–	Jumper Short		
82	SW7	1	Pin header 3P	–	–	Jumper		
83		1	Jumper socket	–	–	Jumper Short		
84	SW8	1	Pin header 3P	–	–	Jumper		
85		1	Jumper socket	–	–	Jumper Short		
86	SW9	0	Pin header 3P	–	–	Jumper		✓
87		0	Jumper socket	–	–	Jumper Short		✓
88	JP1	1	Pin header 2P	–	–	Jumper		
89		1	Jumper socket	–	–	Jumper Short		
90	JP2	1	Pin header 2P	–	–	Jumper		
91		1	Jumper socket	–	–	Jumper Short		
92	JP3	1	Pin header 2P	–	–	Jumper		
93		1	Jumper socket	–	–	Jumper Short		
94	JP4	1	Pin header 2P	–	–	Jumper		

95		1	Jumper socket	–	–	Jumper Short		
96	CON1	1	Connector 4P	–	–	Connector 4P-2.5		
97	IC1	1	TB67S508FTG	TB67S508FTG	TOSHIBA	Motor driver IC	QFN36	
98								
99								
100								

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